
maXTouch 228-node Touchscreen Controller Product Brief

Description

The ATMXT228UD 3.0 uses a unique charge-transfer acquisition engine to implement Microchip's patented capacitive sensing method. Coupled with a state-of-the-art CPU, the entire touchscreen sensing solution can measure, classify and track a number of individual finger touches with a high degree of accuracy in the shortest response time. The ATMXT228UD 3.0 allows for both mutual and self capacitance measurements, with the self capacitance measurements being used to augment the mutual capacitance measurements to produce reliable touch information.

maXTouch[®] Adaptive Sensing Technology

- Up to 14 X (transmit) lines and 24 Y (receive) lines for use by a touchscreen and/or key array
- A maximum of 228 nodes can be allocated to the touch sensor
- Touchscreen size of 7.11 inches (16:9 aspect ratio), assuming a sensor electrode pitch of 6.5 mm. Other sizes are possible with different electrode pitches and appropriate sensor material
- Multiple touch support with up to 10 concurrent touches tracked in real time

Touch Sensor Technology

- On-cell/touch-on display support including OLED and LCD
- Discrete/out-cell support including glass and PET film-based sensors
- Synchronization with display refresh timing capability
- Support for standard (for example, Diamond) and proprietary sensor patterns (review of designs by Microchip or a Microchip-qualified touch sensor module partner is recommended)

Front Panel Material

- Works with PET or glass, including curved profiles (configuration and stack-up to be approved by Microchip or a Microchip-qualified touch sensor module partner)
- 10 mm glass (or 5 mm PMMA) with bare finger (dependent on sensor size, touch size, configuration and stack-up)
- 6 mm glass (or 3 mm PMMA) with multi-finger 5 mm glove (2.7 mm PMMA equivalent) (dependent on sensor size, touch size, configuration and stack-up)

Touch Performance

- Moisture/Water Compensation
 - No false touch with condensation or water drop up to 22 mm diameter
 - One-finger tracking with condensation or water drop up to 22 mm diameter
- Multiple acquisition schemes for robust and sensitive multi-touch sensing, including:
 - Mutual capacitance measurements
 - Self Capacitance measurements
 - P2P Mutual Capacitance measurements
- Noise suppression technology to combat ambient and power-line noise
 - Up to 240 V_{PP} between 1 Hz and 1 kHz sinusoidal waveform (no touches)
 - IEC 61000-4-6, 7 V_{rms}, Class A (normal touch operation) conducted noise immunity
- Stylus Support
 - Supports passive stylus with 1.5 mm contact diameter, subject to configuration, stack-up, and sensor design
- Scan Speed
 - Typical report rate for 10 touches ≥ 90 Hz (subject to configuration)
 - Initial touch latency < 18 ms for first touch from idle (subject to configuration)
 - Configurable for power and speed optimization
- Touch panel failure detection
 - Automatic touch sensor diagnostics during run time to support the implementation of safety critical features
 - Diagnostics reported using dedicated output pin or by standard Object Protocol messages
 - Configurable test limits

Keys

- Up to 16 nodes can be allocated as mutual capacitance sensor keys in addition to the touchscreen, defined as 1 key array (subject to availability of X and Y lines and other configurations)
- Adjacent Key Suppression (AKS) technology is supported for false key touch prevention

Enhanced Algorithms

- Lens bending algorithms to remove display noise
- Touch suppression algorithms to remove unintentional large touches
- Palm Recovery Algorithm for quick restoration to normal state

Data Store

- 60-byte CRC checksummed data area for use as a run-time Product Data Store Area
- 64-byte data area for user's custom data (not CRC checksummed)

Device Security

- Encrypted configuration parameters and touch coordinate reports (OBP messages) using customer's own security key

Power Saving

- Programmable timeout for automatic transition from Active to Idle state
- Pipelined analog sensing detection and digital processing to optimize system power efficiency

Application Interfaces

- I²C client interface for main communication with the device
 - Standard mode (up to 100 kHz)
 - Fast mode (up to 400 kHz)
 - Fast-mode Plus (up to 1 MHz)
- Interrupt to indicate when a message is available
- Additional SPI Debug Interface to read the raw data for tuning and debugging purposes

Power Supply

- Digital (V_{dd}) 3.3V nominal
- Digital I/O (V_{ddIO}) 3.3V nominal
- Analog (AV_{dd}) 3.3V nominal
- High voltage internal X line drive (XV_{dd}) 6.6V with internal voltage pump

Package

- 56-pin XQFN 6 × 6 × 0.4 mm, 0.35 mm pitch

Operating Temperature

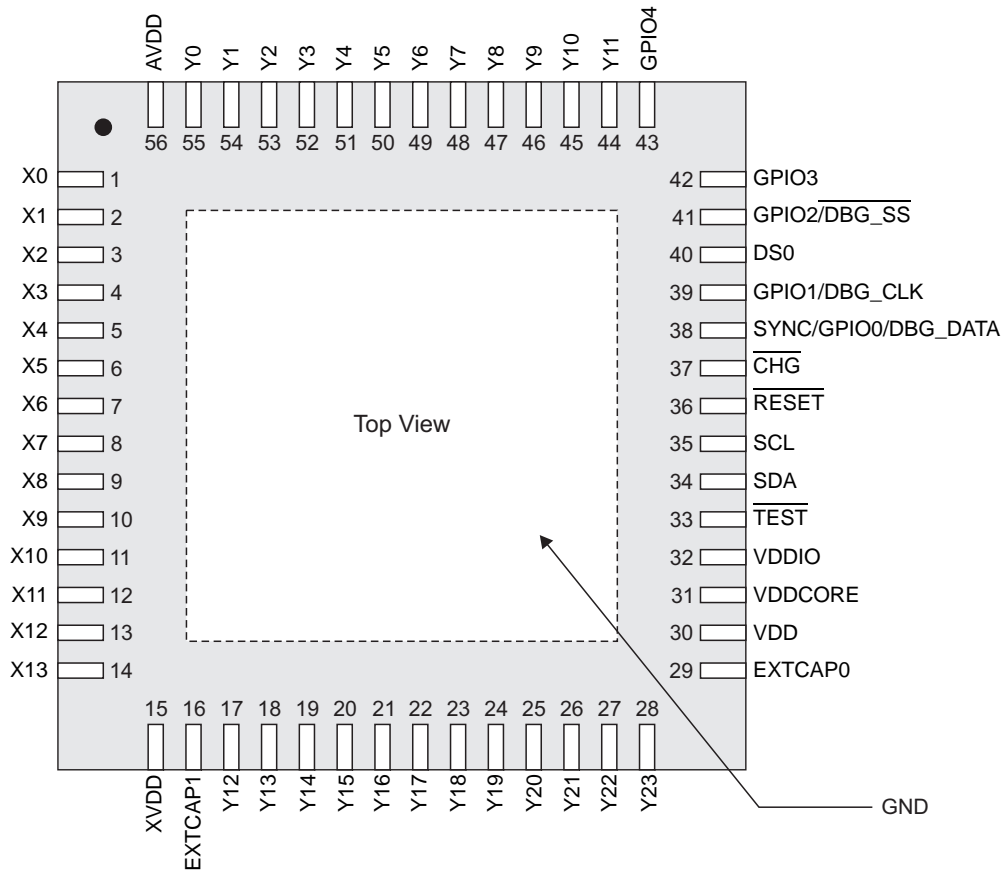
- -40°C to +85°C

Design Services

- Specific design and tuning tools available as maXTouch Studio plug-ins

PIN CONFIGURATION

Pin Configuration – 56-pin XQFN

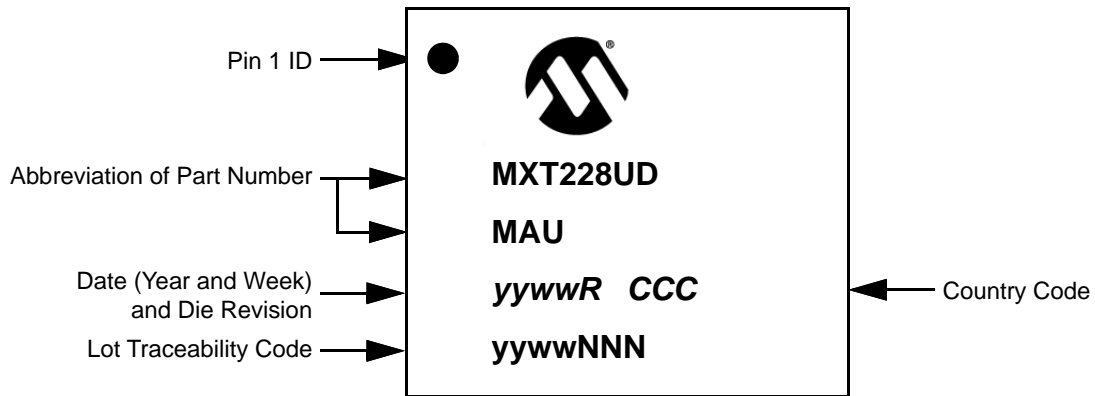


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1.0 PACKAGING INFORMATION

1.1 Package Marking Information

1.1.1 56-PIN XQFN



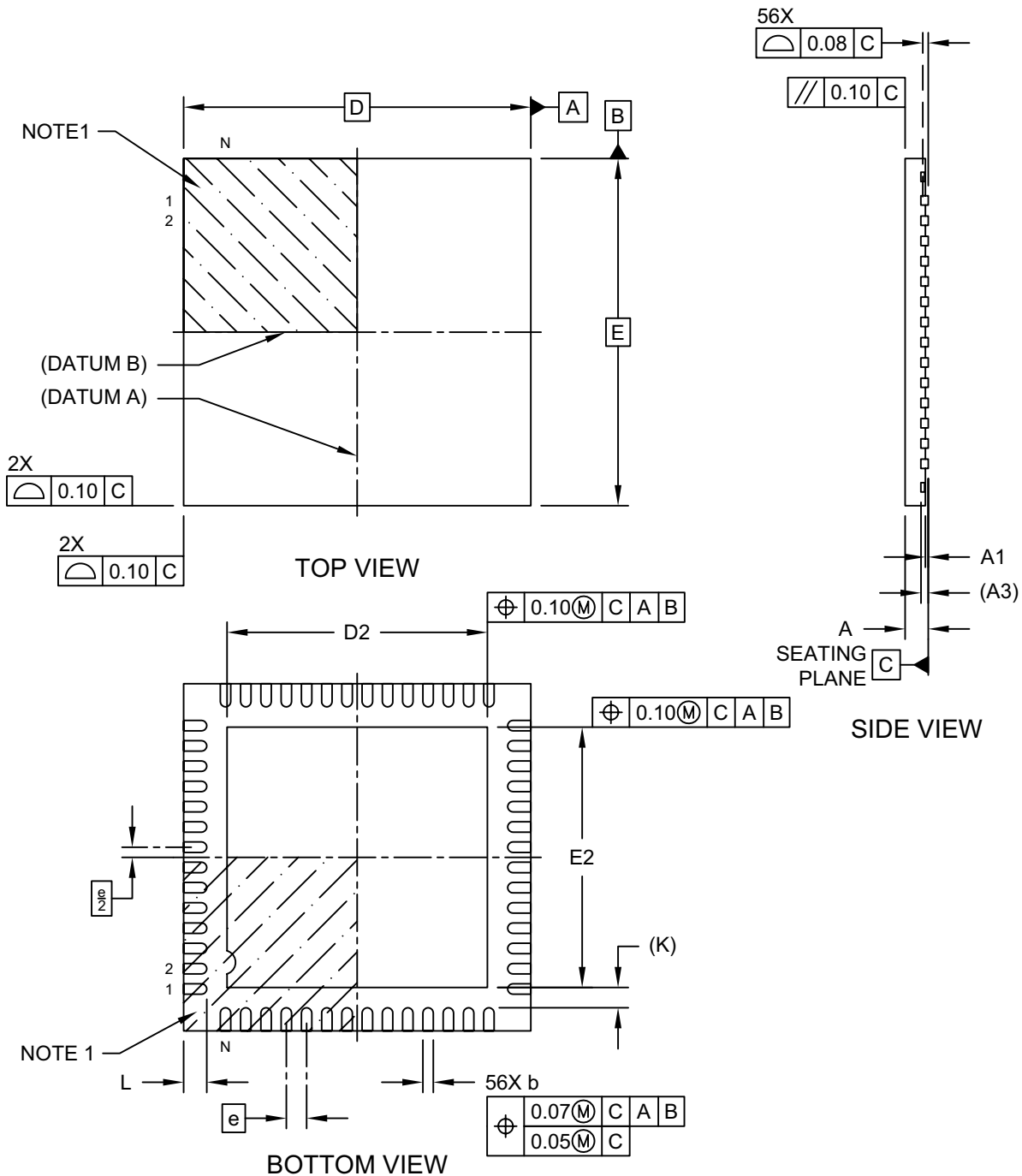
1.1.2 ORDERABLE PART NUMBERS

The product identification system for maXTouch devices is described in ["Product Identification System" on page 9](#). That section also lists example part numbers for the device.

1.2 Package Details

56-Lead Extremely Thin Quad Flatpack No-Lead Package (TWB) - 6x6x0.4 mm Body [XQFN] With 4.5x4.5 mm Exposed Pad; Atmel Legacy Global Package Code ZIX

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

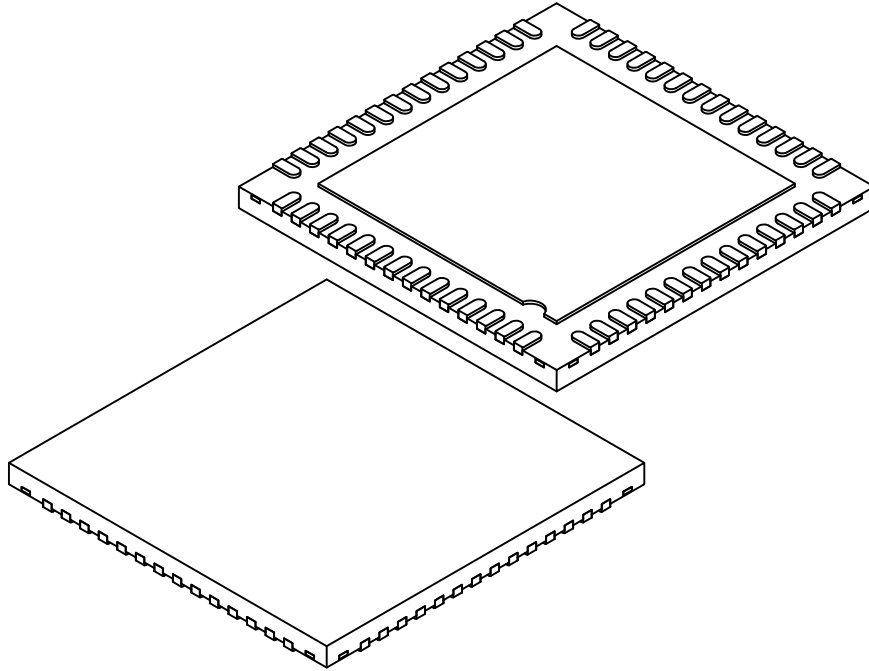


Microchip Technology Drawing C04-21448 Rev A Sheet 1 of 2

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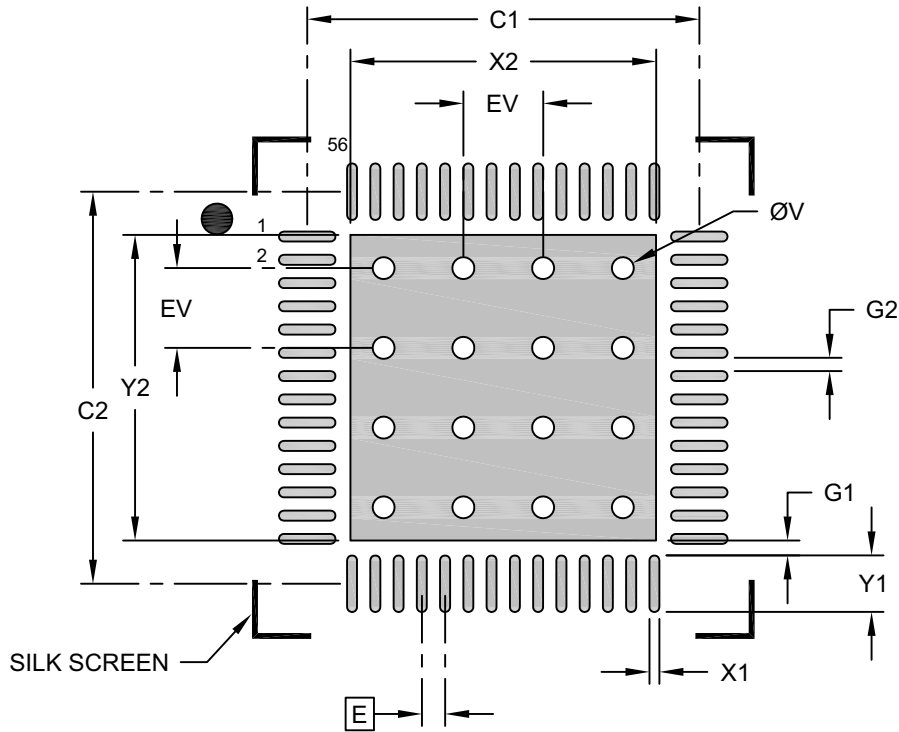
		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Terminals	N		56		
Pitch	e		0.35 BSC		
Overall Height	A		–	–	0.400
Standoff	A1		0.00	–	0.05
Terminal Thickness	A3		0.127 REF		
Overall Length	D		6.00 BSC		
Exposed Pad Length	D2		4.40	4.50	4.60
Overall Width	E		6.00 BSC		
Exposed Pad Width	E2		4.40	4.50	4.60
Terminal Width	b		0.13	0.18	0.23
Terminal Length	L		0.35	0.40	0.45
Terminal-to-Exposed-Pad	K		0.35 REF		

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 REF: Reference Dimension, usually without tolerance, for information purposes only.

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RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.35 BSC		
Optional Center Pad Width	X2			4.60
Optional Center Pad Length	Y2			4.60
Contact Pad Spacing	C1		5.90	
Contact Pad Spacing	C2		5.90	
Contact Pad Width (X56)	X1			0.15
Contact Pad Length (X56)	Y1			0.85
Contact Pad to Center Pad (X56)	G1	0.23		
Contact Pad to Contact Pad (X52)	G2	0.20		
Thermal Via Diameter	V		0.33	
Thermal Via Pitch	EV		1.20	

Notes:

- Dimensioning and tolerancing per ASME Y14.5M
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-23448 Rev A

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APPENDIX A: REVISION HISTORY

Revision A (May 2024)

Initial edition for firmware revision 3.0.AA – Release

PRODUCT IDENTIFICATION SYSTEM

The table below gives details on the product identification system for maXTouch devices. See [“Orderable Part Numbers”](#) below for example part numbers for the ATMXT228UD.

To order or obtain information, for example on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	-XXX	[X]	[X]	[XXX]
Device	Package	Temperature Range	Tape and Reel Option	Pattern
Device:	Base device name			
Package:	C2	=	UFBGA (Ultra Thin Fine-pitch Ball Grid Array)	
	NH	=	UFBGA (Ultra Thin Fine-pitch Ball Grid Array)	
	C4	=	X1FBGA (Extra Thin Fine-pitch Ball Grid Array)	
	MA	=	XQFN (Super Thin Quad Flat No Lead Sawn)	
	MA5	=	XQFN (Super Thin Quad Flat No Lead Sawn)	
Temperature Range:	U	=	-40°C to +85°C (Grade 3)	
Tape and Reel Option: ⁽¹⁾	Blank	=	Standard Packaging (Tube or Tray)	
	R	=	Tape and Reel	
Pattern:	Extension, QTP, SQTP, Code or Special Requirements (Blank Otherwise)			

Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. See [“Orderable Part Numbers”](#) below or check with your Microchip Sales Office for package availability with the Tape and Reel option.

Orderable Part Numbers

Orderable Part Number	Firmware Revision	Family ID	Variant ID	Description
ATMXT228UD-MAU003 (Supplied in trays)	3.0.AA	0xA6	0x1D	56-pin XQFN 6 × 6 × 0.4 mm, RoHS compliant Industrial grade; not suitable for automotive characterization
ATMXT228UD-MAUR003 (Supplied in tape and reel)				

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NOTES:

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